



**THE DATASHEET OF
PI6C20800BAEX**



PI6C20800B

PCI Express® 3.0 1:8 HCSL Clock Buffer

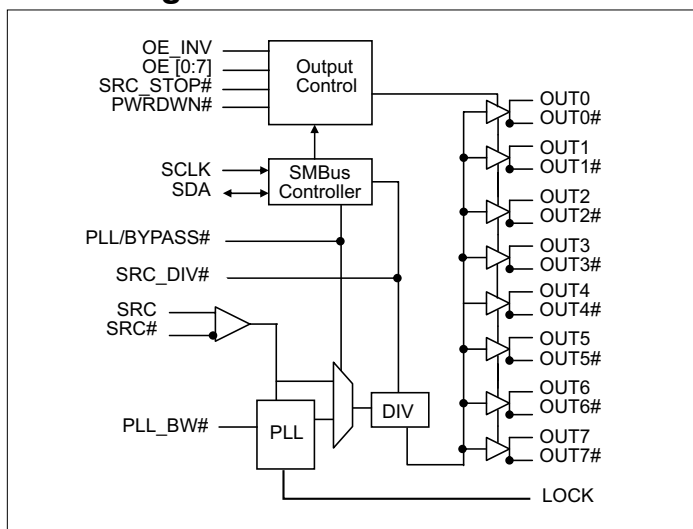
Features

- Phase jitter filter for PCIe 3.0 application
- Eight Pairs of Differential Clocks
- Low skew < 50ps (PI6C20800B), <60ps (PI6C20800BI)
- Low Cycle-to-cycle jitter < 60ps
- Output Enable for all outputs
- Outputs Tristate control via SMBus
- Power Management Control
- Programmable PLL Bandwidth
- PLL or Fanout operation
- 3.3V Operation
- Industrial Temperature Option - PI6C20800BI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. “Green” Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative.
- Packaging (Pb-Free & Green):
 - 48-Pin TSSOP (A)

Description

PI6C20800B is a PCIe 3.0 compliant, high-speed, low-noise differential clock buffer designed to be a companion to PCI Express 3.0 clock generator for Intel server chipsets. The device distributes the differential SRC clock from PCIe clock generator to eight differential pairs of clock outputs either with or without PLL. The input SRC clock can be divided by 2 when SRC_DIV# is LOW. The clock outputs are controlled by input selection of SRC_STOP#, PWRDWN# and SMBus, SCLK and SDA. When input of either SRC_STOP# or PWRDWN# is LOW, the output clocks are Tristated. When PWRDWN# is LOW, the SDA and SCLK inputs must be Tristated.

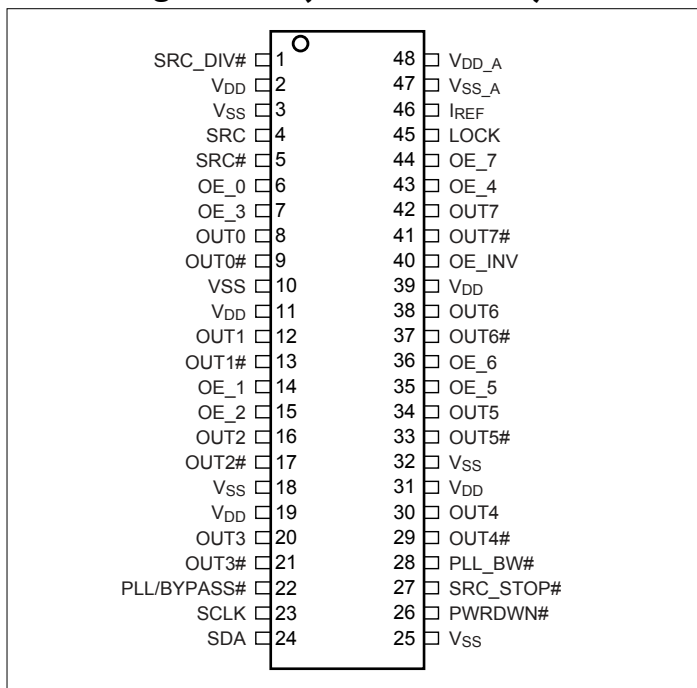
Block Diagram



Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated’s definitions of Halogen- and Antimony-free, “Green” and Lead-free.
3. Halogen- and Antimony-free “Green” products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Configuration (48-Pin TSSOP)



Pin Description

Pin #	Pin Name	Type	Descriptions
1	SRC_DIV#	Input	3.3V LVTTTL input for selecting input frequency divide by 2, active LOW.
4, 5	SRC & SRC#	Input	0.7V Differential SRC input from PI6C410 clock synthesizer
6, 7, 14, 15, 35, 36, 43, 44	OE [0:7]	Input	3.3V LVTTTL input for enabling outputs, active HIGH.
40	OE_INV	Input	3.3V LVTTTL input for inverting the OE, SRC_STOP# and PWRDWN# pins. When 0 = same stage When 1 = OE[0:7], SRC_STOP#, PWRDWN# inverted.
8, 9, 12, 13, 16 17, 20, 21, 29, 30, 33, 34, 37, 38, 41, 42	OUT[0:7] & OUT[0:7]#	Output	0.7V Differential outputs
22	PLL/BYPASS#	Input	3.3V LVTTTL input for selecting fan-out of PLL operation.
23	SCLK	Input	SMBus compatible SCLOCK input
24	SDA	I/O	SMBus compatible SDATA
46	I _{REF}	Input	External resistor connection to set the differential output current
27	SRC_STOP#	Input	3.3V LVTTTL input for SRC stop, active LOW
28	PLL_BW#	Input	3.3V LVTTTL input for selecting the PLL bandwidth
26	PWRDWN#	Input	3.3V LVTTTL input for Power Down operation, active LOW

Pin Description Cont.

Pin #	Pin Name	Type	Descriptions
45	LOCK	Output	3.3V LVTTTL output, transition high when PLL lock is achieved (Latched output)
2, 11, 19, 31, 39	V _{DD}	Power	3.3V Power Supply for Outputs
3, 10, 18, 25, 32	V _{SS}	Ground	Ground for Outputs
47	V _{SS_A}	Ground	Ground for PLL
48	V _{DD_A}	Power	3.3V Power Supply for PLL

Serial Data Interface (SMBus)

This part is a slave only SMBus device that supports indexed block read and indexed block write protocol using a single 7-bit address and read/write bit as shown below.

Address Assignment

A6	A5	A4	A3	A2	A1	A0	W/R
1	1	0	1	1	1	0	0/1

Data Write Protocol

1 bit	7 bits	1	1	8 bits	1	8 bits	1	8 bits	1	8 bits	1	1 bit
Start bit	Slave Addr	W	Ack	Register offset	Ack	Byte Count = N	Ack	Data Byte Offset	Ack	Data Byte N - 1	Ack	Stop bit

Note: Register offset for indicating the starting register for indexed block write and indexed block read. Byte Count in write mode cannot be 0.

Data Read Protocol

1 bit	7 bits	1	1	8 bits	1	1	7 bits	1	1	8 bits	1	8 bits	1	8 bits	1	1 bit
Start bit	Slave Addr	W	Ack	Register offset	Ack	Repeat Start	Slave Addr	R	Ack	Byte Count = N	Ack	Data Byte Offset	Ack	Data Byte N - 1	Not Ack	Stop bit

Note: Register offset for indicating the starting register for indexed block write and indexed block read.

Data Byte 0: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	SRC_DIV# 0 = Divide by 2 1 = Normal	RW	1 = x1	OUT[0:7], OUT[0:7]#	NA
1	PLL/BYPASS# 0 = Fanout 1 = PLL	RW	1 = PLL	OUT[0:7], OUT[0:7]#	NA
2	PLL Bandwidth 0 = HIGH Bandwidth, 1 = LOW Bandwidth	RW	1 = Low	OUT[0:7], OUT[0:7]#	NA
3	RESERVED				
4	RESERVED				
5	RESERVED				
6	SRC_STOP# 0 = Driven when stopped 1 = Tristate	RW	0 = Driven when stopped	OUT[0:7], OUT[0:7]#	
7	PWRDWN# 0 = Driven when stopped 1 = Tristate	RW	0 = Driven when stopped	OUT[0:7], OUT[0:7]#	NA

PI6C20800B

Data Byte 1: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	OUTPUTS enable 1 = Enabled 0 = Disabled	RW	1 = Enabled	OUT0, OUT0#	NA
1		RW	1 = Enabled	OUT1, OUT1#	NA
2		RW	1 = Enabled	OUT2, OUT2#	NA
3		RW	1 = Enabled	OUT3, OUT3#	NA
4		RW	1 = Enabled	OUT4, OUT4#	NA
5		RW	1 = Enabled	OUT5, OUT5#	NA
6		RW	1 = Enabled	OUT6, OUT6#	NA
7		RW	1 = Enabled	OUT7, OUT7#	NA

Data Byte 2: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	Allow control of OUTPUTS with assertion of SRC_STOP# 0 = Free running 1 = Stopped with SRC_Stop#	RW	0 = Free running	OUT0, OUT0#	NA
1		RW	0 = Free running	OUT1, OUT1#	NA
2		RW	0 = Free running	OUT2, OUT2#	NA
3		RW	0 = Free running	OUT3, OUT3#	NA
4		RW	0 = Free running	OUT4, OUT4#	NA
5		RW	0 = Free running	OUT5, OUT5#	NA
6		RW	0 = Free running	OUT6, OUT6#	NA
7		RW	0 = Free running	OUT7, OUT7#	NA

Data Byte 3: Control Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	RESERVED	RW			
1		RW			
2		RW			
3		RW			
4		RW			
5		RW			
6		RW			
7		RW			

PI6C20800B

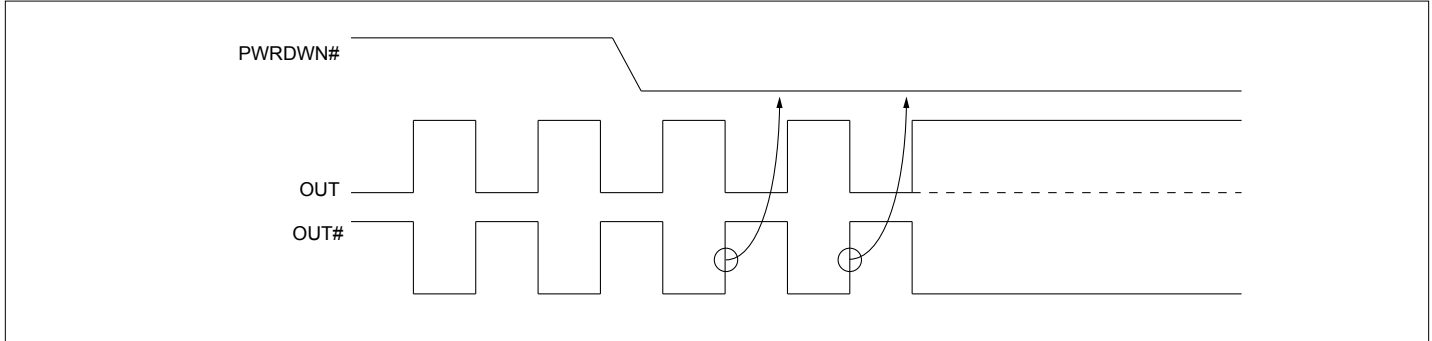
Data Byte 4: Pericom ID Register

Bit	Descriptions	Type	Power Up Condition	Output(s) Affected	Pin
0	Pericom ID	R	0	NA	NA
1		R	0	NA	NA
2		R	0	NA	NA
3		R	0	NA	NA
4		R	0	NA	NA
5		R	1	NA	NA
6		R	0	NA	NA
7		R	0	NA	NA

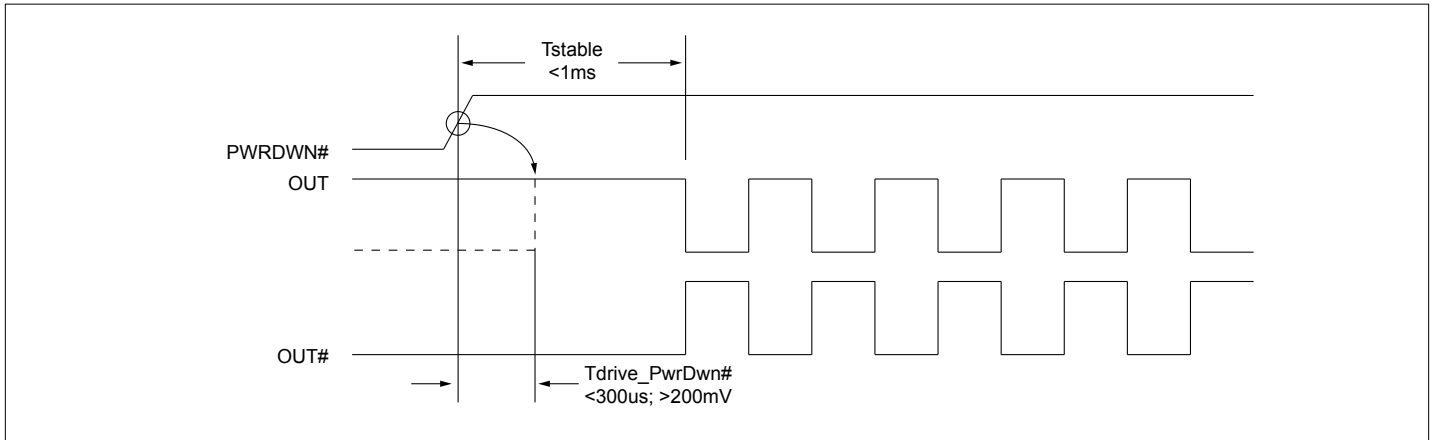
Functionality

PWRDWN#	OUT	OUT#	SRC_Stop#	OUT	OUT#
1	Normal	Normal	1	Normal	Normal
0	$I_{REF} \times 2$ or Float	LOW	0	$I_{REF} \times 6$ or Float	LOW

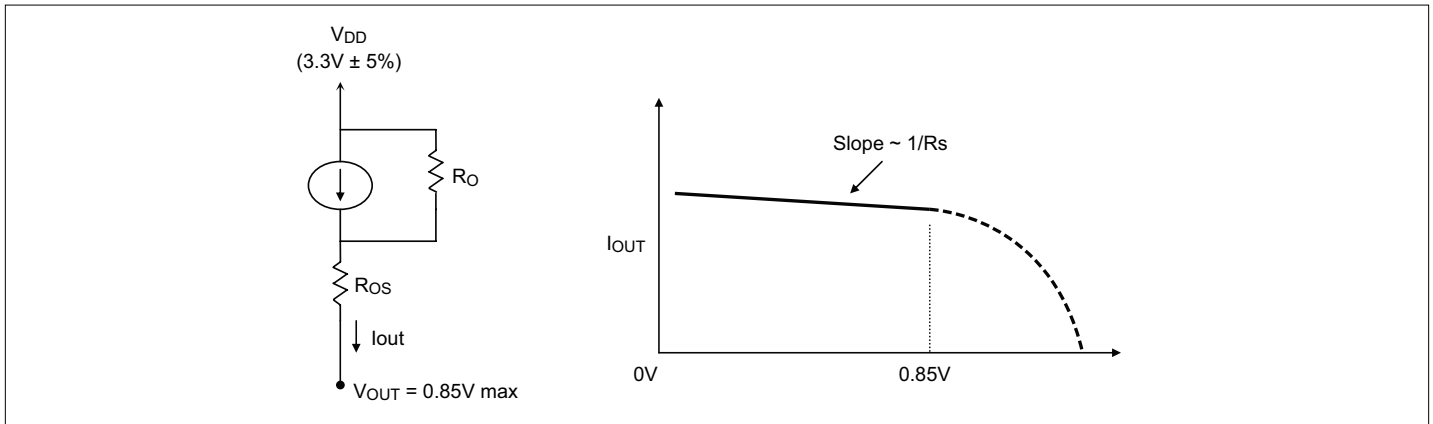
Power Down (PWRDWN# Assertion)



Power Down (PWRDWN# De-assertion)



Current-mode Output Buffer Characteristics of OUT[0:7], OUT[0:7]#



Differential Clock Buffer Characteristics

Symbol	Minimum	Maximum
R_O	3000 Ω	N/A
R_{OS}	unspecified	unspecified
V_{OUT}	N/A	850mV

Current Accuracy

Symbol	Conditions	Configuration	Load	Min.	Max.
I_{OUT}	$V_{DD} = 3.30 \pm 5\%$	$R_{REF} = 475\Omega \text{ 1\%}$ $I_{REF} = 2.32\text{mA}$	Nominal test load for given configuration	$-12\% I_{NOMINAL}$	$+12\% I_{NOMINAL}$

Note: $I_{NOMINAL}$ refers to the expected current based on the configuration of the device.

Differential Clock Output Current

Board Target Trace/Term Z	Reference R, $I_{ref} = V_{DD}/(3 \times R_r)$	Output Current	$V_{OH} @ Z$
100 Ω (100 Ω differential \approx 15% coupling ratio)	$R_{REF} = 475\Omega \text{ 1\%}$, $I_{REF} = 2.32\text{mA}$	$I_{OH} = 6 \times I_{REF}$	0.7V @ 50

Absolute Maximum Ratings⁽¹⁾ (Over operating free-air temperature range)

Symbol	Parameters	Min.	Max.	Units
V_{DD_A}	3.3V Core Supply Voltage	-0.5	4.6	V
V_{DD}	3.3V I/O Supply Voltage	-0.5	4.6	
V_{IH}	Input HIGH Voltage		4.6	
V_{IL}	Input LOW Voltage	-0.5		
T_s	Storage Temperature	-65	150	°C
V_{ESD}	ESD Protection	2000		V
T_j	Junction Temperature		125	°C

Note:

1. Stress beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device.

DC Electrical Characteristics ($V_{DD} = 3.3 \pm 5\%$, $V_{DD_A} = 3.3 \pm 5\%$)

Symbol	Parameters	Condition	Min.	Max.	Units
V_{DD_A}	3.3V Core Supply Voltage		3.135	3.465	V
V_{DD}	3.3V I/O Supply Voltage		3.135	3.465	
V_{IH}	3.3V Input HIGH Voltage		2.0	$V_{DD} + 0.3$	
V_{IL}	3.3V Input LOW Voltage		$V_{SS} - 0.3$	0.8	
I_{IK}	Input Leakage Current	$0 < V_{IN} < V_{DD}$	-5	+5	µA
V_{OH}	3.3V Output HIGH Voltage	$I_{OH} = -1mA$	2.4		V
V_{OL}	3.3V Output LOW Voltage	$I_{OL} = 1mA$		0.4	
I_{OH}	Output HIGH Current	$I_{OH} = 6 \times I_{REF}$ $I_{REF} = 2.32mA$	12.2	15.6	mA
C_{IN}	Logic Input Pin Capacitance		1.5	5	
C_{OUT}	Output Pin Capacitance			6	pF
L_{PIN}	Pin Inductance			7	
I_{DD}	Power Supply Current	$V_{DD} = 3.465V$, $F_{CPU} = 100MHz$		250	mA
I_{SS}	Power Down Current	Driven outputs		80	
I_{SS}	Power Down Current	Tristate outputs		12	
T_A	Ambient Temperature	Commercial (PI6C20800B)	0	70	°C
		Industrial (PI6C20800BI)	-40	85	

AC Switching Characteristics^(1,2,3) ($V_{DD} = 3.3 \pm 5\%$, $V_{DD_A} = 3.3 \pm 5\%$)

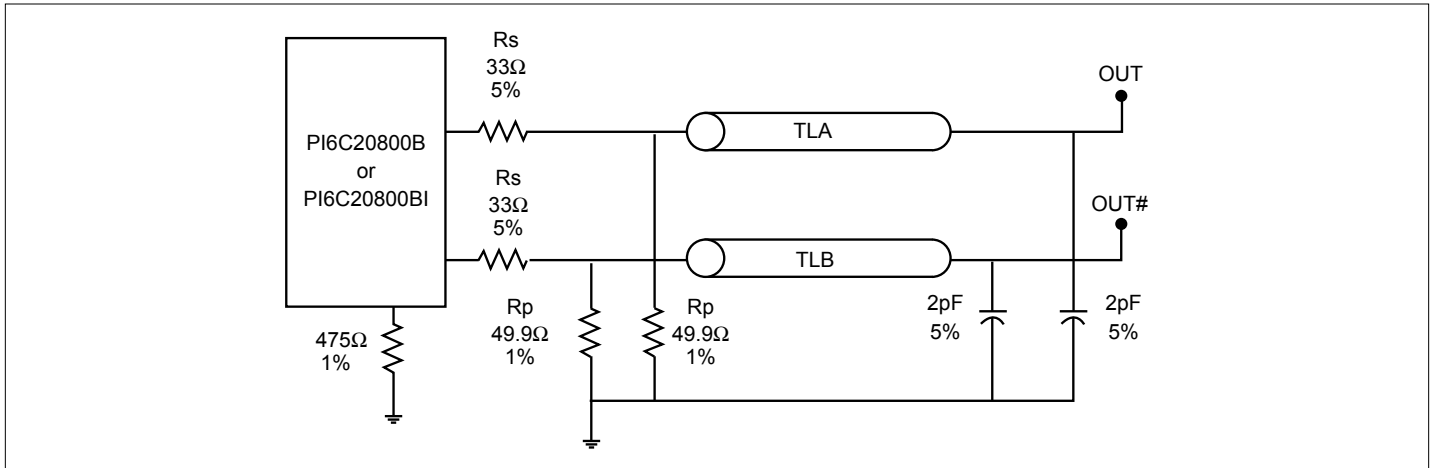
Symbol	Parameters		Min.	Typ.	Max.	Units	Notes	
F_{in}	SRC/SRC# Input Frequency PLL Mode		95		105	MHz	6	
	SRC/SRC# Input Frequency Bypass Mode		95		400	MHz	6	
T_{rise} / T_{fall}	Rise and Fall Time (measured between 0.175V to 0.525V)		175		700	ps	2	
$\Delta T_{rise} / \Delta T_{fall}$	Rise and Fall Time Variation				125		2	
T_{pd}	Input to Output Propagation Delay	PLL Mode	PI6C20800B	-250		250	ps	
			PI6C20800BI	-450		450		
		Bypass Mode	PI6C20800B	-7.5		7.5	ns	
			PI6C20800BI	-8		8		
T_{skew}	Output-to-Output Skew (PI6C20800B)				50	ps	3	
	Output-to-Output Skew (PI6C20800BI)				65		3	
V_{HIGH}	Voltage HIGH (Measured at 100MHz @ 3.3V)		600		900	mV	2	
V_{OVS}	Max. Voltage				1150			
V_{UDS}	Min. Voltage		-300					
V_{LOW}	Voltage LOW		-150		+150		2	
V_{cross}	Absolute crossing point voltages		250		550		2	
ΔV_{cross}	Total Variation of V_{cross} over all edges				140		2	
T_{DC}	Duty Cycle (Measured at 100 MHz)		45		55	%	3	
$T_{jycy-cyc}$	Jitter, Cycle-to-cycle (PLL Mode, Measurement for differential waveform)				60	ps	4	
	Jitter, Cycle-to-cycle (BYPASS mode as additive jitter)							
J_{add}	Additive RMS phase jitter for PCIe 2.0		<0		1	ps	5	
J_{add}	RMS phase jitter for PCIe 3.0	PLL L-BW @ 2M & 5M 1 st H3		1.115	3	ps		
		PLL L-BW @ 2M & 4M 1 st H3		1.211	3			
		PLL L-BW @ 2M & 5M 1 st H3		1.116	3			
		PLL L-BW @ 2M & 4M 1 st H3		1.425	3			
		PLL H-BW @ 2M & 5M 1 st H3		0.646	1			
		PLL H-BW @ 2M & 4M 1 st H3		0.644	1			
		PLL H-BW @ 2M & 5M 1 st H3		0.646	1			
		PLL H-BW @ 2M & 4M 1 st H3		0.579	1			

Notes:

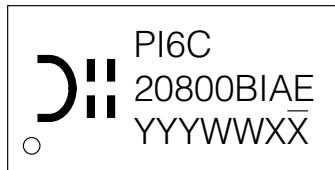
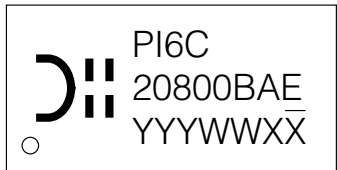
- Test configuration is $R_s = 33.2\Omega$, $R_p = 49.9\Omega$, and 2pF.
- Measurement taken from Single Ended waveform.
- Measurement taken from Differential waveform.
- Measured using M1 timing analyzer from Amherst.
- Additive jitter is calculated from input and output RMS phase jitter by using PCIe 2.0 filter. ($J_{add} = \sqrt{(\text{output jitter})^2 - (\text{input jitter})^2}$)
- 0.5% downspread input

PI6C20800B

Configuration Test Load Board Termination



Part Marking



Y: Die Rev
YY: Year
WW: Workweek
1st X: Assembly Code
2nd X: Fab Code

Y: Die Rev
YY: Year
WW: Workweek
1st X: Assembly Code
2nd X: Fab Code

PI6C20800B

Packaging Mechanical: 48-TSSOP (A)

SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.20
A1	0.05	—	0.15
A2	0.80	1.00	1.05
b	0.17	—	0.27
c	0.09	—	0.20
D	12.40	12.50	12.60
E1	6.00	6.10	6.20
E	7.90	8.10	8.30
e	0.50 BSC		
L1	1.00 REF		
L	0.45	0.60	0.75
S	0.20	—	—
θ	0°	—	8°

Notes:
 1. Controlling Dimension in Millimeters. Angle in Degrees.
 2. Refer JEDEC MO-153F
 3. Package Outline Exclusive of Mold Flash and Metal Burr.

PERICOM
Enabling Serial Connectivity

DATE: 03/30/16

DESCRIPTION: 48-Pin, 240mil Wide TSSOP
 PACKAGE CODE: A (A48)
 DOCUMENT CONTROL #: PD-1501 REVISION: H

16-0065

For latest package info.

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

Ordering Information

Ordering Code	Package Code	Package Description
PI6C20800BAEX	A	48-pin, 240mil Wide (TSSOP)
PI6C20800BIAEX	A	48-pin, 240mil Wide (TSSOP) (Industrial)

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. E = Pb-free and Green
5. X suffix = Tape/Reel

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